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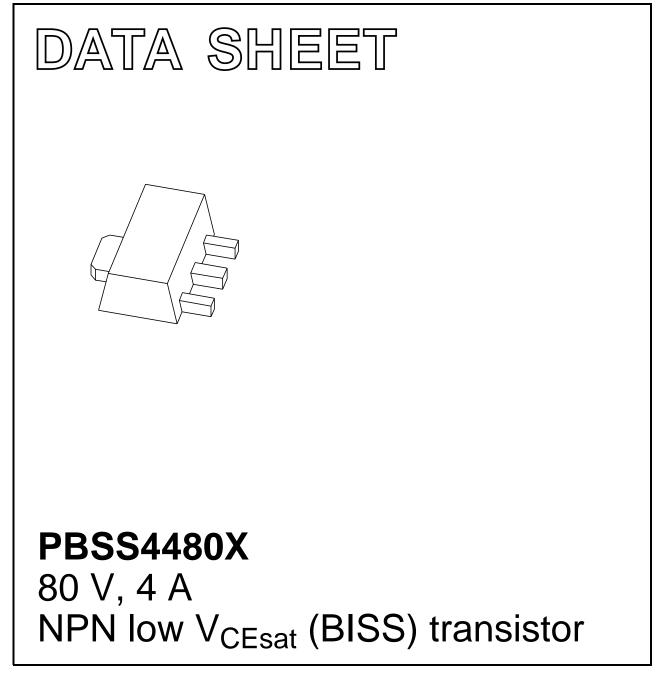
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Team Nexperia

DISCRETE SEMICONDUCTORS



Product data sheet Supersedes data of 2004 Aug 5 2004 Oct 25



80 V, 4 A NPN low V_{CEsat} (BISS) transistor

FEATURES

- High h_{FE} and low V_{CEsat} at high current operation
- High collector current capability: I_C maximum 4 A
- High efficiency leading to less heat generation.

APPLICATIONS

- Medium power peripheral drivers; e.g. fan, motor
- Strobe flash units for DSC and mobile phones
- Inverter applications; e.g. TFT displays
- Power switch for LAN and ADSL systems
- Medium power DC-to-DC conversion
- Battery chargers.

DESCRIPTION

NPN low V_{CEsat} transistor in a SOT89 (SC-62) plastic package.

PNP complement: PBSS5480X.

MARKING

TYPE NUMBER	MARKING CODE ⁽¹⁾
PBSS4480X	*1Y

Note

- 1. * = p: made in Hong Kong.
 - * = t: made in Malaysia.
 - * = W: made in China.

ORDERING INFORMATION

SYMBOL	PARAMETER	MAX.	UNIT
V _{CEO}	collector-emitter voltage	80	V
I _C	collector current (DC) 4		А
I _{CM}	peak collector current	10	А
R _{CEsat}	equivalent on-resistance	54	mΩ

PINNING

PIN	DESCRIPTION	
1	emitter	
2	collector	
3	base	

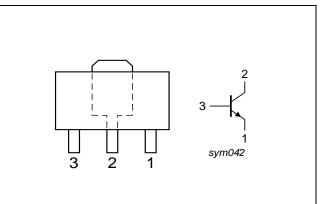


Fig.1 Simplified outline (SOT89) and symbol.

TYPE NUMBER		PACKAGE		
	NAME DESCRIPTION VERSIO			
PBSS4480X	 plastic surface mounted package; collector pad for good heat transfer; 3 leads 		SOT89	

PBSS4480X

LIMITING VALUES

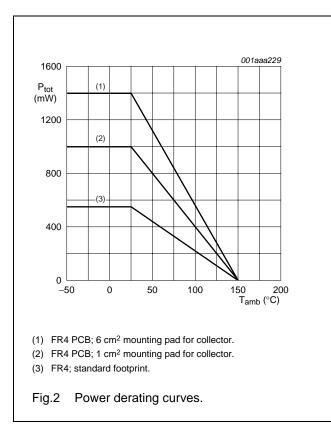
In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter	_	80	V
V _{CEO}	collector-emitter voltage	open base	_	80	V
V _{EBO}	emitter-base voltage	open collector	-	5	V
I _C	collector current (DC)	note 4	_	4	А
I _{CRM}	repetitive peak collector current	$t_p \le 10 \text{ ms}; \delta \le 0.1$	_	6	А
I _{CM}	peak collector current	t = 1 ms or limited by $T_{j(max)}$	_	10	А
IB	base current (DC)		_	1	А
I _{BM}	peak base current	t ≤ 300 μs	_	2	А
P _{tot}	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$			
		notes 1 and 2	_	2.5	W
		note 2	_	550	mW
		note 3	-	1	W
		note 4	-	1.4	W
		note 5	-	1.6	W
Tj	junction temperature		_	150	°C
T _{amb}	ambient temperature		-65	+150	°C
T _{stg}	storage temperature		-65	+150	°C

Notes

1. Operated under pulsed conditions; pulse width $t_p \leq$ 10 ms; duty cycle $\delta \leq$ 0.2.

- 2. Device mounted on a printed-circuit board, single-sided copper, tin-plated and standard footprint.
- 3. Device mounted on a printed-circuit board, single-sided copper, tin-plated and mounting pad for collector 1 cm².
- 4. Device mounted on a printed-circuit board, single-sided copper, tin-plated and mounting pad for collector 6 cm².
- 5. Device mounted on a 7 cm² ceramic printed-circuit board, 1 cm² single-sided copper and tin-plated. For other mounting conditions, see *"Thermal considerations for SOT89 in the General Part of associated Handbook"*.



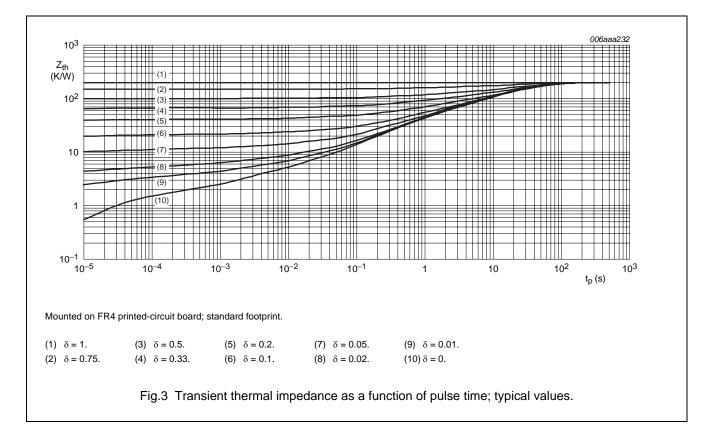
PBSS4480X

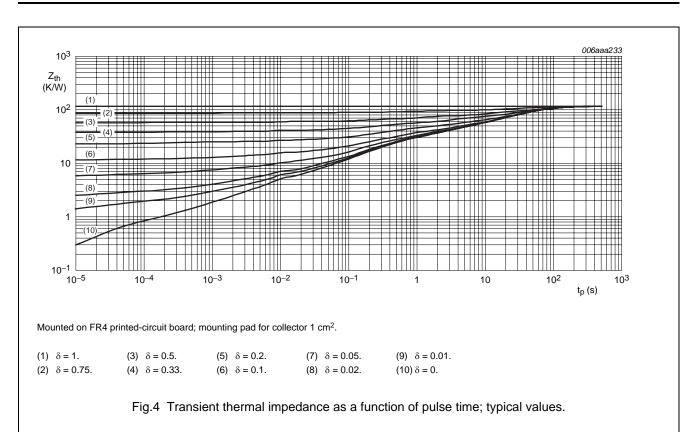
THERMAL CHARACTERISTICS

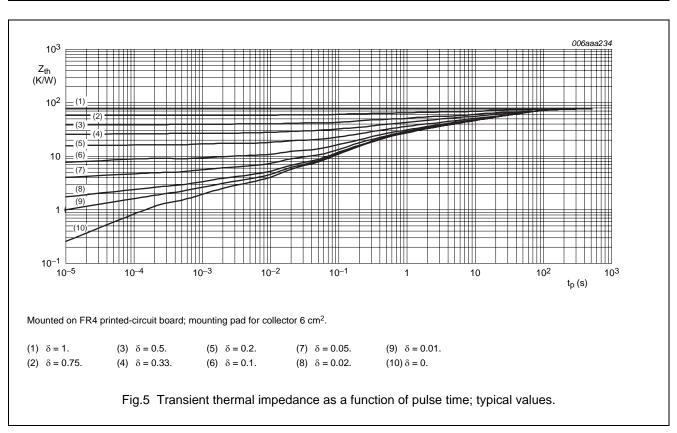
SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th(j-a)}	thermal resistance from junction	in free air		
	to ambient	notes 1 and 2	50	K/W
		note 2	225	K/W
		note 3	125	K/W
		note 4	90	K/W
		note 5	80	K/W
R _{th(j-s)}	thermal resistance from junction to soldering point		16	K/W

Notes

- 1. Operated under pulsed conditions; pulse width $t_p \le 10$ ms; duty cycle $\delta \le 0.2$.
- 2. Device mounted on a printed-circuit board, single-sided copper, tin-plated and standard footprint.
- 3. Device mounted on a printed-circuit board, single-sided copper, tin-plated and mounting pad for collector 1 cm².
- 4. Device mounted on a printed-circuit board, single-sided copper, tin-plated and mounting pad for collector 6 cm².
- 5. Device mounted on a 7 cm² ceramic printed-circuit board, 1 cm² single-sided copper and tin-plated. For other mounting conditions, see *"Thermal considerations for SOT89 in the General Part of associated Handbook"*.







PBSS4480X

CHARACTERISTICS

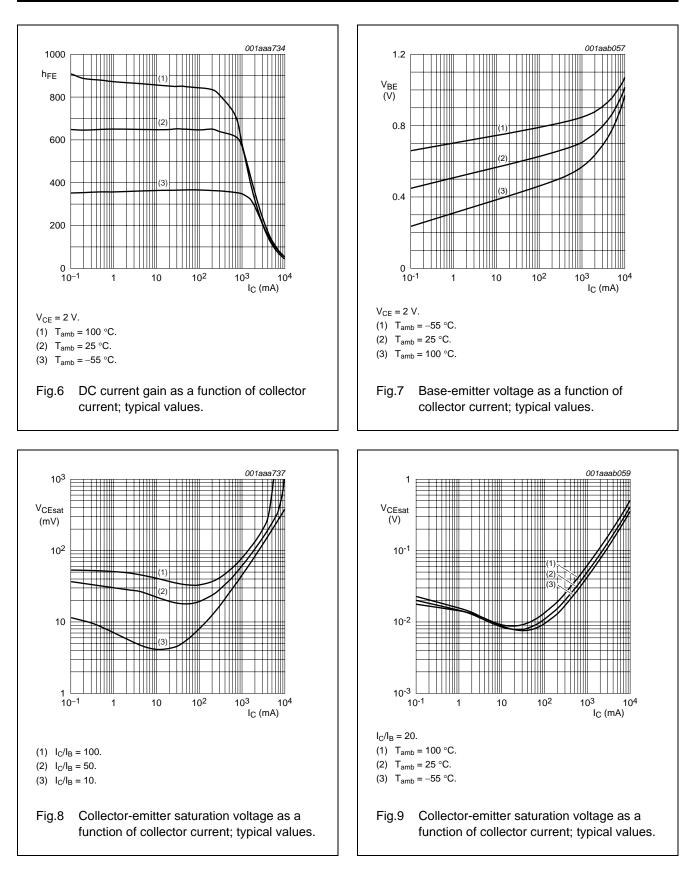
 T_{amb} = 25 °C unless otherwise specified.

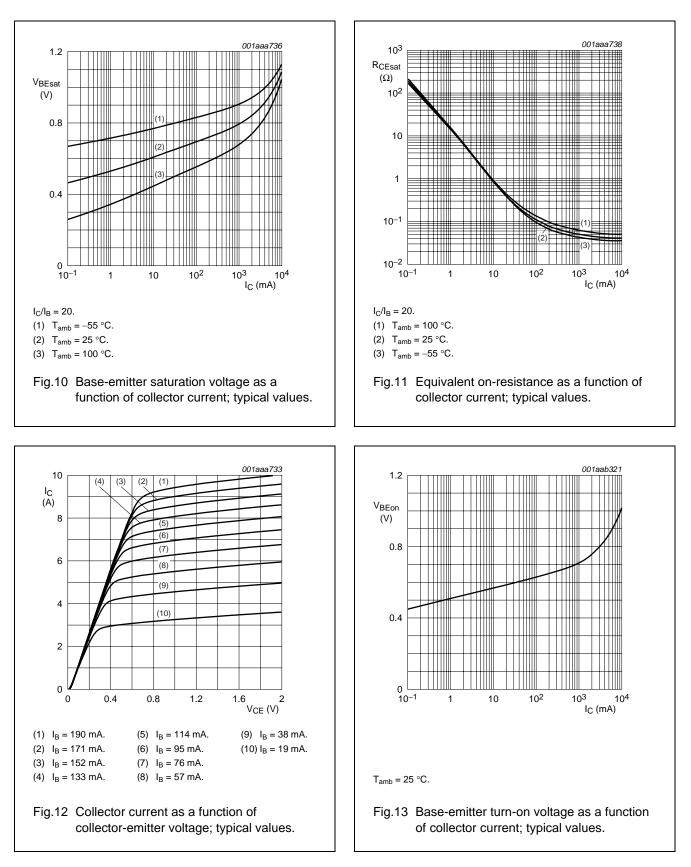
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I _{CBO}	collector-base cut-off current	V _{CB} = 80 V; I _E = 0 A	_	_	100	nA
		$V_{CB} = 80 \text{ V}; \text{ I}_{E} = 0 \text{ A};$ T _j = 150 °C	_	-	50	μΑ
I _{CES}	collector-emitter cut-off current	V _{CE} = 80 V; V _{BE} = 0 V	-	-	100	nA
I _{EBO}	emitter-base cut-off current	V _{EB} = 5 V; I _C = 0 A	-	-	100	nA
h _{FE}	DC current gain	$V_{CE} = 2 \text{ V}; \text{ I}_{C} = 0.5 \text{ A}$	250	400	-	-
		$V_{CE} = 2 V; I_{C} = 1 A; note 1$	250	400	-	-
		$V_{CE} = 2 V; I_{C} = 2 A; note 1$	175	270	-	_
		$V_{CE} = 2 V; I_{C} = 4 A; note 1$	80	140	-	-
V _{CEsat}	collector-emitter saturation	I _C = 0.5 A; I _B = 50 mA	-	25	40	mV
	voltage	I _C = 1 A; I _B = 50 mA	-	55	80	mV
		I _C = 2 A; I _B = 40 mA	-	110	160	mV
		$I_{C} = 4 \text{ A}; I_{B} = 200 \text{ mA};$ note 1	_	170	230	mV
		$I_{C} = 5 \text{ A}; I_{B} = 500 \text{ mA};$ note 1	_	200	270	mV
R _{CEsat}	equivalent on-resistance	$I_{C} = 5 \text{ A}; I_{B} = 500 \text{ mA};$ note 1	_	40	54	mΩ
V _{BEsat}	base-emitter saturation voltage	I _C = 0.5 A; I _B = 50 mA	_	0.78	0.85	V
		I _C = 1 A; I _B = 50 mA	_	0.79	0.9	V
		$I_{C} = 1 \text{ A}; I_{B} = 100 \text{ mA};$ note 1	_	0.82	0.95	V
		$I_{C} = 4 \text{ A}; I_{B} = 400 \text{ mA};$ note 1	_	0.95	1.05	V
V _{BEon}	base-emitter turn-on voltage	I _C = 2 A; V _{CE} = 2 V	-	0.78	0.85	V
f _T	transition frequency	$I_{C} = 100 \text{ mA}; V_{CE} = 10 \text{ V};$ f = 100 MHz	120	150	-	MHz
C _c	collector capacitance	$I_E = i_e = 0 \text{ A}; V_{CB} = 10 \text{ V};$ f = 1 MHz	_	35	50	pF

Note

1. Pulse test: $t_p \leq 300~\mu\text{s};~\delta \leq 0.02.$

80 V, 4 A NPN low V_{CEsat} (BISS) transistor

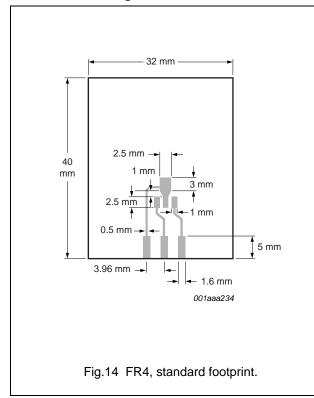


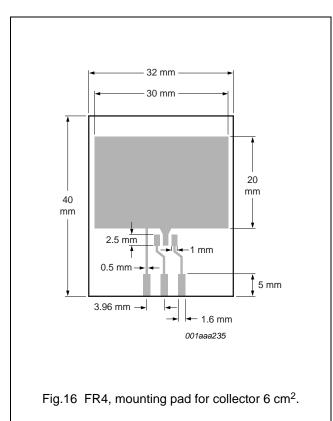


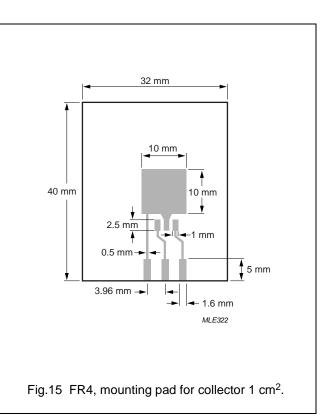
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80 V, 4 A NPN low V_{CEsat} (BISS) transistor

Reference mounting conditions



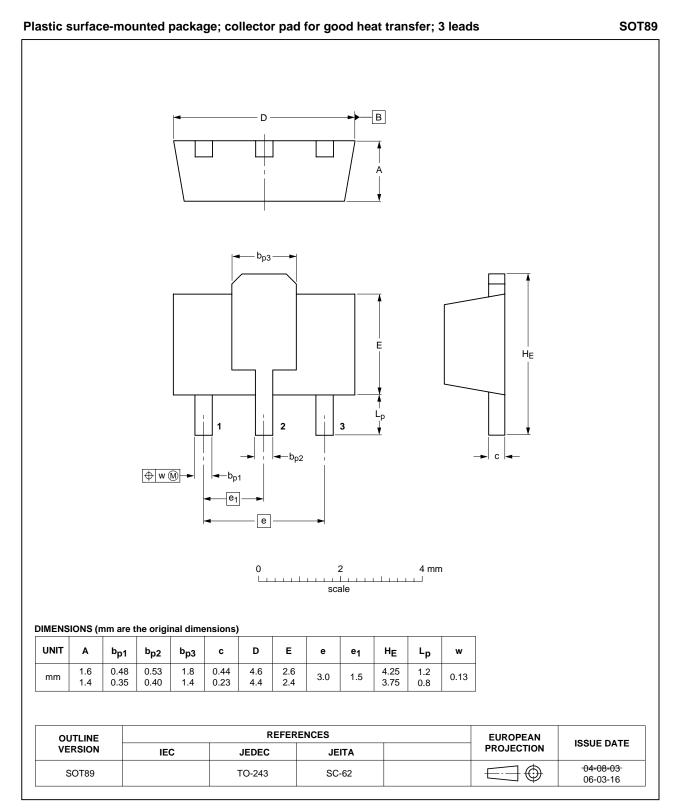




S) transistor

PBSS4480X

PACKAGE OUTLINE



PBSS4480X

DATA SHEET STATUS

DOCUMENT STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

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NXP Semiconductors

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Contact information

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